

## High Current FET Driver

#### **FEATURES**

- Totem Pole Output with 6A Source/Sink Drive
- 3ns Delay
- 20ns Rise and Fall Time into 2.2nF
- 8ns Rise and Fall Time into 30nF
- 4.7V to 18V Operation
- Inverting and Non-Inverting Outputs
- Under-Voltage Lockout with Hysteresis
- Thermal Shutdown Protection
- MINIDIP and Power Packages

#### DESCRIPTION

The UC1710 family of FET drivers is made with a high-speed Schottky process to interface between low-level control functions and very high-power switching devices-particularly power MOSFET's. These devices accept low-current digital inputs to activate a high-current, totem pole output which can source or sink a minimum of 6A.

Supply voltages for both  $V_{IN}$  and  $V_{C}$  can independently range from 4.7V to 18V. These devices also feature under-voltage lockout with hysteresis.

The UC1710 is packaged in an 8-pin hermetically sealed dual in-line package for -55°C to +125°C operation. The UC2710 and UC3710 are specified for a temperature range of -40°C to +85°C and 0°C to +70°C respectively and are available in either an 8-pin plastic dual in-line or a 5-pin, TO-220 package. Surface mount devices are also available.

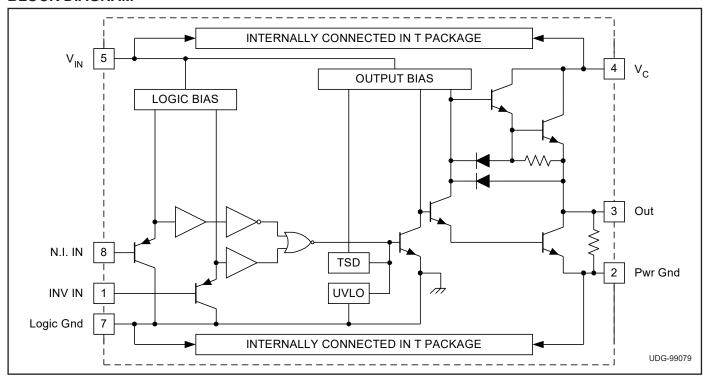
## ORDERING INFORMATION

|          | TEMPERATURE<br>RANGE | PACKAGE          |
|----------|----------------------|------------------|
| UC1710J  | –55°C to +125°C      | 8 pin CDIP       |
| UC2710DW | –40°C to +85°C       | Not Available    |
| UC2710J  |                      | Not Available    |
| UC2710N  |                      | 8 pin PDIP       |
| UC2710T  |                      | 5 pin TO220      |
| UC3710DW | 0°C to +70°C         | 16 pin SOIC-wide |
| UC3710N  |                      | 8 pin PDIP       |
| UC3710T  |                      | 5 pin TO220      |

### TRUTH TABLE

| Out  Count of the second of th | L | N.I.<br>H<br>H<br>L | INV<br>H<br>L<br>H |
|--|---|---------------------|--------------------|
|--|---|---------------------|--------------------|

## **BLOCK DIAGRAM**



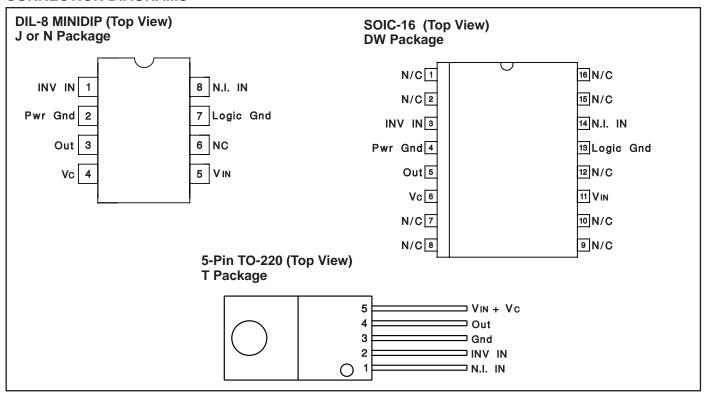
## **ABSOLUTE MAXIMUM RATINGS**

|   | N-Package                           | J-Package  | T-Package       |
|---|-------------------------------------|--|-----------------|
| Supply Voltage, Vin   | 20V                                 | 20V  | 20V             |
| Collector Supply Voltage, V <sub>C</sub>  | 20V                                 | 20V  | 20V             |
| Operating Voltage   | 18V                                 |  | 18V             |
| Output Current (Source or Sink)   |                                     |  |                 |
| Steady-State  | ± 500mA                             | ± 500mA  | ± 1A            |
| Digital Inputs  | –0.3V-VIN                           | 0.3V - V <sub>IN</sub>   | 0.3V - VIN      |
| Power Dissipation at Ta=25°C  | 1W                                  | 1W   | 3W              |
| Power Dissipation at T (Case) = 25°C  | 2W                                  | 2W   | 25W             |
| Operating Junction Temperature5   | 55°C to +150°C                      | . –55°C to +150°C  | -55°C to +150°C |
| Storage Temperature6  | 5°C to +150°C                       | . –65°C to +150°C  | -65°C to +150°C |
| Lead Temperature (Soldering, 10 seconds)  | 300°C                               | 300°C  | 300°C           |
| Operating Voltage Output Current (Source or Sink) Steady-State Digital Inputs Power Dissipation at Ta=25°C Power Dissipation at T (Case) = 25°C Operating Junction Temperature Storage Temperature -6 | ± 500mA0.3V-VIN 1W 2W 5°C to +150°C | ±500mA<br>0.3V - V <sub>IN</sub><br>1W<br>2W<br>55°C to +150°C<br>65°C to +150°C |                 |

Note 1: All currents are positive into, negative out of the specified terminal.

Note 2: Consult Unitrode Integrated Circuits databook for information regarding thermal specifications and limitations of packages.

## **CONNECTION DIAGRAMS**



# **ELECTRICAL CHARACTERISTICS:** Unless otherwise stated, these specifications apply for $V_{IN} = V_C = 15V$ , No load, $T_A = T_{.I}$

| PARAMETERS                     | TEST CONDITIONS  | MIN | TYP | MAX | UNITS |
|--------------------------------|--|-----|-----|-----|-------|
| V <sub>IN</sub> Supply Current | $V_{IN}$ =18V, $V_{C}$ =18V, Output Low                |     | 26  | 35  | mA    |
|                                | V <sub>IN</sub> =18V, V <sub>C</sub> =18V, Output High |     | 21  | 30  | mA    |
| V <sub>C</sub> Supply Current  | V <sub>IN</sub> =18V, V <sub>C</sub> =18V, Output Low  |     | 1.5 | 5.0 | mA    |
|                                | V <sub>IN</sub> =18V, V <sub>C</sub> =18V,Output High  |     | 5.0 | 8   | mA    |
| UVLO Threshold                 | V <sub>IN</sub> High to Low                            | 3.8 | 4.1 | 4.4 | V     |
|                                | V <sub>IN</sub> Low to High                            | 4.1 | 4.4 | 4.8 | V     |

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| PARAMETERS  | TEST CONDITIONS                       | MIN | TYP  | MAX | UNITS |
|---|---------------------------------------|-----|------|-----|-------|
| UVLO Threshold Hysteresis                                   |                                       | 0.1 | 0.3  | 0.5 | V     |
| Digital Input Low Level                                     |                                       |     |      | 0.8 | V     |
| Digital Input High Level                                    |                                       | 2.0 |      |     | V     |
| Digital Input Current                                       | Digital Input = 0.0V                  | -70 | -4.0 |     | μΑ    |
| Output High Sat., V <sub>C</sub> – V <sub>O</sub>           | I <sub>O</sub> = -100mA               |     | 1.35 | 2.2 | V     |
|   | I <sub>O</sub> = -6A                  |     | 3.2  | 4.5 | V     |
| Output Low Sat., Vo   | I <sub>O</sub> = 100mA                |     | 0.25 | 0.6 | V     |
|   | I <sub>O</sub> = 6A                   |     | 3.4  | 4.5 | V     |
| Thermal Shutdown  |                                       |     | 165  |     | °C    |
| From Inv., Input to Output (Note 3, 4):                     |                                       |     |      |     |       |
| Rise Time Delay   | CL = 0                                |     | 35   | 70  | ns    |
|   | CL = 2.2nF                            |     | 35   | 70  | ns    |
|   | CL = 30nF                             |     | 35   | 70  | ns    |
| 10% to 90% Rise   | CL = 0                                |     | 20   | 40  | ns    |
|   | CL = 2.2nF                            |     | 25   | 40  | ns    |
|   | CL = 30nF                             |     | 85   | 150 | ns    |
| Fall Time Delay   | CL = 0                                |     | 35   | 70  | ns    |
|   | CL = 2.2nF                            |     | 35   | 70  | ns    |
|   | CL = 30nF                             |     | 35   | 80  | ns    |
| 90% to 10% Fall   | CL = 0                                |     | 15   | 40  | ns    |
|   | CL = 2.2nF                            |     | 20   | 40  | ns    |
|   | CL = 30nF                             |     | 85   | 150 | ns    |
| From N.I. Input to Output (Note 3,4):                       |                                       |     |      |     |       |
| Rise Time Delay   | CL = 0                                |     | 35   | 70  | ns    |
|   | CL = 2.2nF                            |     | 35   | 70  | ns    |
|   | CL = 30nF                             |     | 35   | 70  | ns    |
| 10% to 90% Rise   | CL = 0                                |     | 20   | 40  | ns    |
|   | CL = 2.2nF                            |     | 25   | 40  | ns    |
|   | CL = 30nF                             |     | 85   | 150 | ns    |
| Fall Time Delay   | CL = 0                                |     | 35   | 70  | ns    |
|   | CL = 2.2nF                            |     | 35   | 70  | ns    |
|   | CL = 30nF                             |     | 35   | 80  | ns    |
| 90% to 10% Fall   | CL = 0                                |     | 15   | 40  | ns    |
|   | CL = 2.2nF                            |     | 20   | 50  | ns    |
|   | CL = 30nF                             |     | 85   | 150 | ns    |
| Total Supply Current at 200kHz Input<br>Switching Frequency | T <sub>A</sub> = 25°C (Note 5) CL = 0 |     | 30   | 40  | mA    |

Note: 3. Delay measured from 50% input change to 10% output change.

Note: 4. Those parameters with CL = 30nF are not tested in production.

Note: 5. Inv. Input pulsed at 50% duty cycle with N.I. Input = 3V. or N.I. Input pulsed at 50% duty cycle with Inv. Input = 0V.





8-Apr-2018

## **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package | Pins | Package | Eco Plan                   | Lead/Ball Finish    | MSL Peak Temp       | Op Temp (°C) | Device Marking       | Samples |
|------------------|--------|--------------|---------|------|---------|----------------------------|---------------------|---------------------|--------------|----------------------|---------|
|                  | (1)    |              | Drawing |      | Qty     | (2)                        | (6)                 | (3)                 |              | (4/5)                |         |
| 5962-0152001QPA  | ACTIVE | CDIP         | JG      | 8    | 1       | TBD                        | A42                 | N / A for Pkg Type  | -55 to 125   | 0152001QPA<br>UC1710 | Samples |
| 5962-0152001VPA  | ACTIVE | CDIP         | JG      | 8    | 1       | TBD                        | A42                 | N / A for Pkg Type  | -55 to 125   | 0152001VPA<br>UC1710 | Samples |
| UC1710J          | ACTIVE | CDIP         | JG      | 8    | 1       | TBD                        | A42                 | N / A for Pkg Type  | -55 to 125   | UC1710J              | Samples |
| UC1710J883B      | ACTIVE | CDIP         | JG      | 8    | 1       | TBD                        | A42                 | N / A for Pkg Type  | -55 to 125   | 0152001QPA<br>UC1710 | Samples |
| UC2710N          | ACTIVE | PDIP         | Р       | 8    | 50      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU           | N / A for Pkg Type  | -40 to 85    | UC2710N              | Samples |
| UC2710NG4        | ACTIVE | PDIP         | Р       | 8    | 50      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU           | N / A for Pkg Type  | -40 to 85    | UC2710N              | Samples |
| UC2710T          | ACTIVE | TO-220       | KC      | 5    | 50      | Green (RoHS<br>& no Sb/Br) | CU SN               | N / A for Pkg Type  | -40 to 85    | UC2710T              | Samples |
| UC2710TG3        | ACTIVE | TO-220       | KC      | 5    | 50      | Green (RoHS<br>& no Sb/Br) | CU SN               | N / A for Pkg Type  | -40 to 85    | UC2710T              | Samples |
| UC3710DW         | ACTIVE | SOIC         | DW      | 16   | 40      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU           | Level-2-260C-1 YEAR | 0 to 70      | UC3710DW             | Samples |
| UC3710DWG4       | ACTIVE | SOIC         | DW      | 16   | 40      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU           | Level-2-260C-1 YEAR | 0 to 70      | UC3710DW             | Samples |
| UC3710N          | ACTIVE | PDIP         | Р       | 8    | 50      | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   Call TI | N / A for Pkg Type  | 0 to 70      | UC3710N              | Samples |
| UC3710NG4        | ACTIVE | PDIP         | Р       | 8    | 50      | Green (RoHS<br>& no Sb/Br) | Call TI             | N / A for Pkg Type  | 0 to 70      | UC3710N              | Samples |
| UC3710T          | ACTIVE | TO-220       | KC      | 5    | 50      | Green (RoHS<br>& no Sb/Br) | CU SN               | N / A for Pkg Type  | 0 to 70      | UC3710T              | Samples |
| UC3710TG3        | ACTIVE | TO-220       | KC      | 5    | 50      | Green (RoHS<br>& no Sb/Br) | CU SN               | N / A for Pkg Type  | 0 to 70      | UC3710T              | Samples |

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

## PACKAGE OPTION ADDENDUM



8-Apr-2018

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
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#### OTHER QUALIFIED VERSIONS OF UC1710, UC1710-SP, UC3710:

Catalog: UC3710, UC1710

Military: UC1710

Space: UC1710-SP

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



## **PACKAGE OPTION ADDENDUM**

8-Apr-2018

• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

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### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan            | Lead finish/<br>Ball material | MSL Peak Temp       | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|-------------------------------|---------------------|--------------|-------------------------|---------|
| 5962-0152001QPA  | ACTIVE | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type  | -55 to 125   | 0152001QPA<br>UC1710    | Samples |
| 5962-0152001VPA  | ACTIVE | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type  | -55 to 125   | 0152001VPA<br>UC1710    | Samples |
| UC1710J          | ACTIVE | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type  | -55 to 125   | UC1710J                 | Samples |
| UC1710J883B      | ACTIVE | CDIP         | JG                 | 8    | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type  | -55 to 125   | 0152001QPA<br>UC1710    | Samples |
| UC2710N          | ACTIVE | PDIP         | Р                  | 8    | 50             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type  | -40 to 85    | UC2710N                 | Samples |
| UC3710DW         | ACTIVE | SOIC         | DW                 | 16   | 40             | RoHS & Green        | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 70      | UC3710DW                | Samples |
| UC3710DWG4       | ACTIVE | SOIC         | DW                 | 16   | 40             | RoHS & Green        | NIPDAU                        | Level-2-260C-1 YEAR | 0 to 70      | UC3710DW                | Samples |
| UC3710N          | ACTIVE | PDIP         | Р                  | 8    | 50             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type  | 0 to 70      | UC3710N                 | Samples |
| UC3710NG4        | ACTIVE | PDIP         | Р                  | 8    | 50             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type  | 0 to 70      | UC3710N                 | Samples |
| UC3710T          | ACTIVE | TO-220       | KC                 | 5    | 50             | RoHS & Green        | SN                            | N / A for Pkg Type  | 0 to 70      | UC3710T                 | Samples |
| UC3710TG3        | ACTIVE | TO-220       | KC                 | 5    | 50             | RoHS & Green        | SN                            | N / A for Pkg Type  | 0 to 70      | UC3710T                 | Samples |

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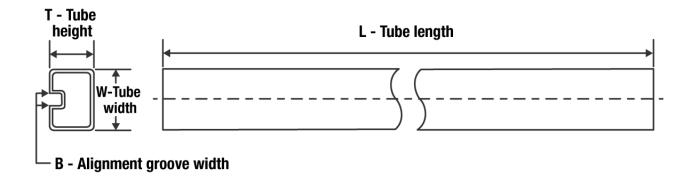
Military - QML certified for Military and Defense Applications

• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application



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## **TUBE**



#### \*All dimensions are nominal

| All dimensions are nominal |              |              |      |     |        |        |        |        |
|----------------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| Device                     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
| UC2710N                    | Р            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| UC3710DW                   | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC3710DWG4                 | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC3710N                    | Р            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| UC3710NG4                  | Р            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| UC3710T                    | KC           | TO-220       | 5    | 50  | 546    | 31     | 11930  | 3.17   |
| UC3710TG3                  | KC           | TO-220       | 5    | 50  | 546    | 31     | 11930  | 3.17   |

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